Transistors

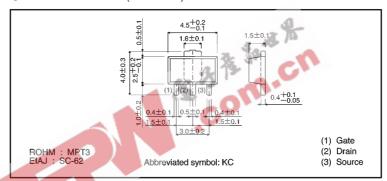
Small switching (60V, 2A) 25K2463

Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Wide SOA (safe operating area).
- 4) Low-voltage drive (4V).
- 5) Easily designed drive circuits.
- 6) Easy to parallel.

●Structure Silicon N-channel MOSFET

●External dimensions (Units: mm)



● Absolute maximum ratings (Ta = 25°C)

| Parameter | | Symbol | Limits | Unit |
|-------------------------|------------|--------|-----------------------|------------|
| Drain-source voltage | | Voss | 60 | V |
| Gate-source voltage | | Vgss | ±20 | V |
| Drain current | Continuous | ΙD | 2 | Α |
| | Pulsed | IDP*1 | 8 | А |
| Reverse drain current | Continuous | IDR | 2 | А |
| | Pulsed | IDRP*1 | 8 | Α |
| Total power dissipation | | P□ | 0.5 2*2 | W |
| Channel temperature | | Tch | 150 | $^{\circ}$ |
| Storage temperature | | Tstg | -55~ + 150 | °C |

Packaging specifications

| Туре | Package | Taping |
|---------|------------------------------|--------|
| | Code | T100 |
| | Basic ordering unit (pieces) | 1000 |
| 2SK2463 | | 0 |

Transistors 2SK2463

●Electrical characteristics (Ta = 25°C)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Test Conditions |
|---------------------------------|----------|------|------|------|------|--|
| Gate-source leakage | lgss | _ | _ | ±100 | nA | V _{GS} =±20V, V _{DS} =0V |
| Drain-source breakdown voltage | V(BR)DSS | 60 | _ | _ | ٧ | In=1mA, Vgs=0V |
| Zero gate voltage drain current | loss | _ | _ | 10 | μΑ | V _{DS} =60V, V _{GS} =0V |
| Gate threshold voltage | VGS(th) | 1.0 | _ | 2.5 | ٧ | V _{DS} =10V, I _D =1mA |
| Static drain-source on-state | D-+ | _ | 0.30 | 0.38 | Ω | In=1A, Vgs=10V |
| resistance | RDS(on) | _ | 0.45 | 0.58 | | In=1A, Vgs=4V |
| Forward transfer admittance | Yfs * | 1.2 | _ | _ | S | In=1A, Vns=10V |
| Input capacitance | Ciss | _ | 200 | _ | рF | V _{DS} =10V |
| Output capacitance | Coss | _ | 80 | _ | рF | Vgs=0V |
| Reverse transfer capacitance | Crss | _ | 50 | _ | pF | f=1MHz |
| Turn-on delay time | td(on) | _ | 10 | - | ns | lo=1A, Voo≒30V |
| Rise time | tr | _ | 25 | 7 | ns | V _{GS} =10V |
| Turn-off delay time | td(off) | - | 50 | 7 フ | ns | RL=30 Ω |
| Fall time | tr | | 50 | | ns | R _G =10 Ω |
| Reverse recovery time | trr | ₹÷ | 70 | _ | ns | IDR=2A, VGS=0V, di/dt=50A/ μS |

^{*} Pw≦300 μs, Duty cycle≦1%

•Electrical characteristic curves

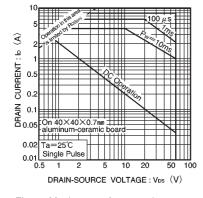


Fig.1 Maximum safe operating area

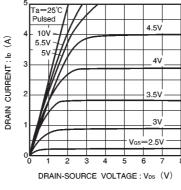


Fig.2 Typical output characteristics

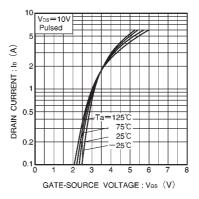


Fig.3 Typical transfer characteristics

Transistors 2SK2463

Electrical characteristic curves

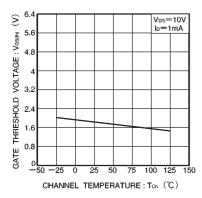


Fig.4 Gate threshold voltage vs. channel temperature

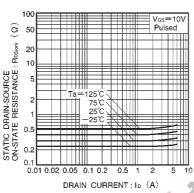


Fig.5 Static drain-source on-state resistance vs. drain current (I)

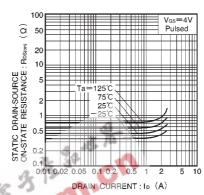


Fig.6 Static drain-source on-state resistance vs. drain current (II)

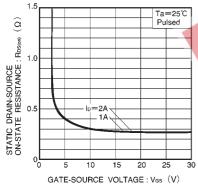


Fig.7 Static drain-source on-state resistance vs. gate-source voltage

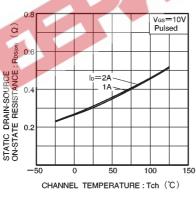


Fig.8 Static drain-source on-state resistance vs. channel temperature

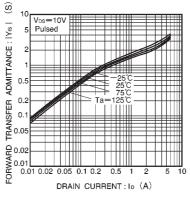


Fig.9 Forward transfer admittance vs. drain current

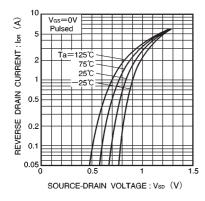


Fig.10 Reverse drain current vs. source-drain voltage (I)

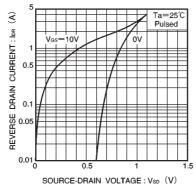


Fig.11 Reverse drain current vs. source-drain voltage (I)

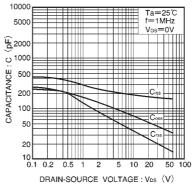


Fig.12 Typical capacitance vs. drain-source voltage

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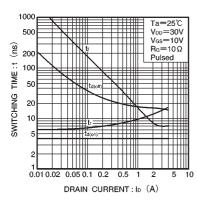


Fig.13 Switching characteristics (See Figures 16 and 17 for the measurement circuit and resultant waveforms)

Fig.14 Reverse recovery time vs. reverse drain current

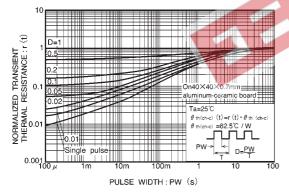
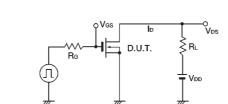


Fig.15 Normalized transient thermal resistance vs. pulse width



Switching characteristics measurement circuit

Fig.16 Switching time measurement circuit

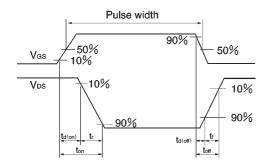


Fig.17 Switching time waveforms